



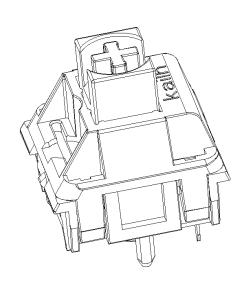


Document Number:

KH-PS2205-07

产品规格书

Product Specification



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<u>P/N:</u>	=		Title:		
CPG151101S157			PG1	511Keyboard	Switch
Rev.	ECN	Release and Revision Description:	Prepared By /Date:	Checked By/Date:	Approved By/Date:
A		New releasing 初版发行	王枝轩 2022-05-10	陶崇阳 2022-05-10	郑建军 2022-05-10



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1. Scope/范围:

This Product Specification covers the requirement of Mechanical Keyboard switch on product performance, test methods and quality assurance provisions.

本规格书内容涵盖机械键盘开关产品的要求,包括性能指标、测试方法及质量保证方面等。

2. Product Application/产品应用:

Mainly applied on computer keyboards, cash registers, industrial equipment and Man-Machine interface.

主要适用于电脑键盘, 收银机、工业设备和人机界面。

3. Technology Parameters/技术参数

Ambient Humidity 工作湿度: 45~85% R.H.; Operating Temperature Range 使用温度范围: -10℃~+70℃;

Storage Temperature Range 保存温度范围: -20℃~+70℃;

Suggested storage period 贮存期限: about 6 months 最多 6 个月

Require the tin part on the switch terminals should keep good after storage guarantee date 要求贮存期后开关端子部分上锡仍然良好。

Normal Condition:

Ambient temperature 环境温度: 20±2℃

Relative humidity 相对湿度: 65%±5% R.H.; Air pressure 气压: 86~101KPa;

Solder Ability 可焊性: 锡铅焊 245±5℃ 5±0.5s; 无铅焊 255±5℃ 5±0.5s:

Withstand Soldering Temperature 耐焊接热: 波焊焊接: 260±5℃ 5±0.5s;

4. Ratings/额定性能要求

Rating 额定负荷: 12V AC/DC max.2V DC min.

10mA AC/DC max.10 μ A DC min;

Insulation Resistance 绝缘电阻: ≥100MΩ/DC 500V;

Withstand Voltage 耐电压: 100V AC 1 Minute; Mechanical Life 机械寿命: 50,000,000 Cycles.

5. Profile Dimensions /外形尺寸









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Electrical Performance/电气性能

Item 项目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求
6.1	Contact Resistance 接触电阻	Static load: (Operation force)x2, which is applied on the center of Switch stem. 静态负载: 动作力的 2 倍,施加在手柄中心. Measurement tool: Contact resistance Meter. 测量工具: 微电流接触电阻计(1KHz, 20mV,5~50mA) 在低电流(≤100mA)条件下测试. Measured at low current (200mA or less).	200mΩ Max 200mΩ以下
6.2	Insulation Resistance 绝缘电阻	Apply a Voltage of DC 500 V for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body. 输入 500V DC 电压 1 分钟,按如下接触方法测试: (1) 端子与端子之间. (2) 端子与外壳之间.	100MΩ Min 100 兆欧以上
6.3	Dielectric withstanding voltage 耐电压	Apply a Voltage of AC100 V (50~60Hz) for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body. 输入 100V AC 电压 1 分钟,按如下接触方法测试: (1) 端子与端子之间. (2) 端子与外壳之间.	No evidence of breakdown 无瞬断、击穿等破坏.
6.4	Bouncing 触点抖动	Operation speed: 3~4 times/s 操作速度: 每秒 3~4 次 Oscillo scope 示波器 Switch Bouncing Test Circuit 抖动测定回路.	Before Life cycle: On:5ms MAX,5 毫秒以下 Off: 5ms MAX,5 毫秒以下 After Life cycle: On:10ms MAX,10 毫秒以下 Off: 10ms MAX,10 毫秒以下



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7. Mechanical Performance/机械性能

Item 项 目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求
7.1	Load Curve 荷重曲线	Place the vertical direction of switch operation and gradually increase the load applied to the center of the stem until it stop. 开关的动作方向为垂直放置,向手柄中心逐渐施加负荷直到停止. Force-Travel-diagram 操作力-行程-图解 120 100 80 00 1 2 3 4 行程(mm)	See page 11 见第 11 页
7.2	Loading parameter 荷重参数	Place the vertical direction of switch operation and gradually increase the load applied to the center of the stem until it stop. 开关的动作方向为垂直放置,向手柄中心逐渐施加负荷直到停止.	See page 11 见第 11 页



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7.3	Static Strength 静止强度	A static load of 3kgf direction of button oper period of 60 seconds. 在手柄动作方向施加 3 后测试参数.	eration for a			•	
7.4	Stem Pull Strength 手柄拉拔强 度	Break by a pull force a direction of stem oper 在推柄动作方向反向垂的程度.	ation.		5kg	ıf Min	
7.5	Shock 机械冲击	Measured by acco condition: (1) Acceleration: 80g (2) Cycles of test:3 cyclerations, for a tot 试验次数: 每个方次.	g 加速度 cles each in 6 al of 18 cycles.		7.2.	eet No.6, 7.1, 7.2	
7.6	Life Test 寿命测试	1) D.C.12V 10mA resi D.C 12V 10mA resi D.C 12V 10mA resi 2) Operation speed: 5 动作速度: 5-6 3 3) Push force: 150g 按力: 150gf 4) Operation number: 动作次数: 50,000	电阻负荷 5-6 times / s 次/ 秒 f 50,000,000cy	cles	1000 m 接触电阻 Bouncir 触点抖动 Operation Variation 30% 操作力的	resistanc Ω Max 且: 1000 ፭ g: 10ms 力: 10 毫 on force: n rate with 力变化范围 0%以内.	wy Servent Se



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8. Environmental Performance/环境性能

Item 项目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求
8.1	Cold test 耐寒性	(1) Temperature: - 20±2℃ 温度: -20±2℃ (2) Duration of test: 48h 持续时间: 48 小时 (3) Take off a drop water 去掉水珠 (4) Standard conditions after test: 1h 试验后的放置条件: 1 小时	Contact resistance: 200m Ω Max Shall meet: No. 6.2 to 6.4 No. 7.1 to 7.2 接触电阻 200m Ω以下满足: No. 6.2 to 6.4 No. 7.1 to 7.2
8.2	Heat test 耐热性	(1) Temperature: 70±2℃ 温度: 70±2℃ (2) Duration of test: 48h 持续时间: 48 小时 (3) Take off a drop water 去掉水珠 (4) Standard conditions after test: 1h 试验后的放置条件: 1 小时	Contact resistance: 200m Ω Max Shall meet: No. 6.2 to 6.4 No. 7.1 to 7.2 接触电阻 200m Ω以下 满足: No. 6.2 to 6.4 No. 7.1 to 7.2
8.3	Temperature cycle 温度循环	(1) Test cycles: 5 cycles 试验周期: 5 个周期 (2) Standard condition after test:1h 试验后的放置条件: 1 小时 Temperature Duration of test 持续时间 1 cycle 20±5℃ 1h -20±2℃ 1h 20±5℃ 1h 70±5℃ 1h	Contact resistance: 200m Ω Max Shall meet: No. 6.2 to 6.4 No. 7.1 to 7.2 接触电阻 200m Ω以下 满足: No. 6.2 to 6.4 No. 7.1 to 7.2



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CPG151101S157 KH-PS2205-07 Soldering area: T/2 of PWB thickness. (PWB: T=1.6mm) 焊接面积:印刷基板的 1/2 厚度处 Soldering temperature: 260 ±5 °C Soldering time: $5\pm0.5s$ 焊接温度: 260+5℃ 焊接时间: 5±0.5 秒 Appearance: 8.4 Soldering heat test No abnormality. 波峰焊温度曲线图 (单波峰) 耐焊接热 「emperature(℃)温度 外观无异常 200 焊接区 → Time(sec)时间 5sec±0.5s 60sec max Lead-tin soldering 锡铅焊接: Soldering temperature: 245±5°C Soldering time: 5 ± 0.5 s 焊接温度: 245±5℃ At least 90% of surface 焊接时间: 5±0.5 秒 area of immersed Solder ability portion shall be covered 8.5 可焊性 Lead free soldering 无铅焊接: by solder. Soldering temperature: 255±5°C 浸焊面积大于90%以上. Soldering time: $5\pm0.5s$ 焊接温度: 255±5℃ 焊接时间: 5±0.5 秒



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B.6 Humidity test 耐湿性 Humidity test 耐湿性 Humidity test 耐湿性 Apply the following environment to test: 根据下列条件进行测试: (1) Temperature: 60±2℃ (2) relative humidity: 90~95% R.H. Humidity test 特续时间: 48 小时 (4) Take off a drop water 去掉水珠 (5) Standard conditions after test: 1h 试验后的放置条件: 1 小时 Apply the following environment to test: 根据下列条件进行测试: (1) Temperature: 35±5℃ 温度: 35±5℃; (2) Salt water density: 5±1% 盘求浓度: 5±1%; (3) Duration: 12hours 持续时间: 12 小时; (4) After test, the salt deposit shall be removed by running water. Contact resistance: 200m Ω Max Shall meet: No. 6.2 to 6.4 No. 7.1 to 7.2 接触电阻 200m Ω以下 满足: No. 6.2 to 6.4 No. 7.1 to 7.2 Appearance: No corrosion spot, no crack, no base plate naked. 外观: 无腐蚀点, 无裂纹, 无裸露基材. Contact Resistance: 200 m Ω Max Contact Resistance: 200 m Ω Max				
8.6 Humidity test 相对湿度:90~95% R.H.			(1) Temperature : 60±2°C	Contact resistance:
Humidity test			温度: 60±2℃	200m Ω Max
Humidity test with test test test test test test test te			(2) relative humidity: 90~95% R.H.	
8.6 test 持续时间:48 小时 接触电阻 200m □以下 满足: No. 6.2 to 6.4 No. 7.1 to 7.2 接触电阻 200m □以下 满足: No. 6.2 to 6.4 No. 7.1 to 7.2 Apply the following environment to test: 根据下列条件进行测试: No corrosion spot, no crack, no base plate naked. 外观:无腐蚀点,无裂纹,		Humidity	相对湿度:90~95% R.H.	
持续时间: 48 小时 按照电阻 200m分片 满足:	8.6	•	(3) Duration of test: 48h	
(4) Take off a drop water 去掉水珠 (5) Standard conditions after test: 1h 试验后的放置条件: 1 小时 Apply the following environment to test: 根据下列条件进行测试: (1) Temperature: 35±5℃ 温度: 35±5℃; (2) Salt water density: 5±1% 盐水浓度: 5±1%; (3) Duration: 12hours 持续时间: 12 小时; (4) After test, the salt deposit shall be	0.0		持续时间: 48 小时	
(5) Standard conditions after test: 1h 试验后的放置条件: 1 小时 Apply the following environment to test: 根据下列条件进行测试: (1) Temperature: 35±5℃ 温度: 35±5℃; (2) Salt water density: 5±1% 盐雾测试 (3) Duration: 12hours 持续时间: 12 小时; (4) After test, the salt deposit shall be		147 175 177	(4) Take off a drop water	=
以验后的放置条件: 1 小时 Apply the following environment to test: 根据下列条件进行测试: (1) Temperature: 35±5℃ 温度: 35±5℃; 温度: 35±5℃; (2) Salt water density: 5±1% 盐水浓度: 5±1%; (3) Duration: 12hours 持续时间: 12 小时; (4) After test, the salt deposit shall be			去掉水珠	
Apply the following environment to test: 根据下列条件进行测试: (1) Temperature: 35±5℃ 温度: 35±5℃; (2) Salt water density: 5±1% 盐水浓度: 5±1%; (3) Duration: 12hours 持续时间: 12 小时; (4) After test, the salt deposit shall be			(5) Standard conditions after test: 1h	No. 7.1 to 7.2
根据下列条件进行测试: (1) Temperature: 35±5℃ 温度: 35±5℃; (2) Salt water density: 5±1% 盐水浓度: 5±1%; (3) Duration: 12hours 持续时间: 12 小时; (4) After test, the salt deposit shall be			试验后的放置条件: 1 小时	
(1) Temperature: 35±5℃			'''	Appearance:
8.7 Salt Spray				
8.7 Salt Spray			(1) Temperature : $35\pm5^{\circ}$ C	· ·
8.7			温度: 35±5℃;	
盘水浓度: 5±1%; (3) Duration: 12hours 持续时间: 12 小时; (4) After test, the salt deposit shall be			(2) Salt water density: $5\pm1\%$	
(3) Duration: 12hours 持续时间: 12 小时; (4) After test, the salt deposit shall be	8.7		盐水浓度: 5±1%;	九裸露基材.
(4) After test, the salt deposit shall be Contact Resistance:			(3) Duration: 12hours	
(4) After test, the sait deposit shall be				Contact Desistance
removed by running water.			` '	
			1	
实验后将盐沉积物用水冲掉 接触电阻: 200 毫欧以下			实验后将盐沉积物用水冲掉	按熈电阻: 200 電队以下





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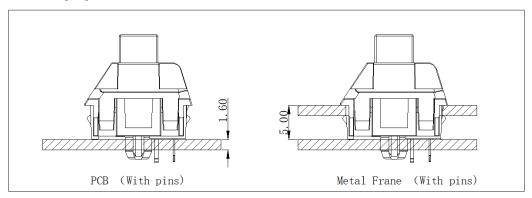
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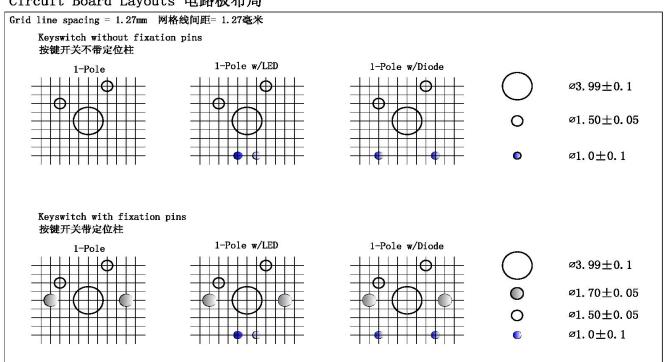
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9. Recommended PCB Layout 推荐的 PCB 安装焊盘规格

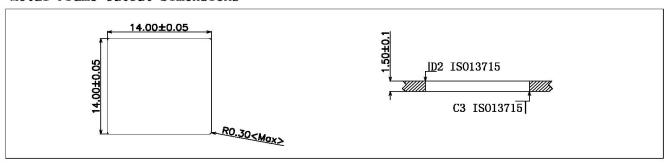
Mounting Options 安装选项



Circuit Board Layouts 电路板布局



Metal Frame Cutout Dimensions





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10. Loading Parameter (FP/OP/PT/OF / OT/TT) Specification 荷重参数规格:

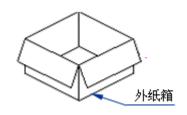
Parameter	Unit	Specification	Remark
TT(总行程)	mm	4.0±0.4	
PT(导通行程)	mm	1.9±0.4	
OT(过行程)	mm	1.3	Min
OF(操作力)	gf	40±10	

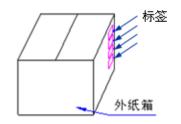
11. Packaging 包装

Packaging type: Tray, 1000Pcs/Tray, 4000Pcs/Carton.

包装方式: Tray 盘,1000Pcs/盘,4000Pcs/箱.







12.Precaution 注意事项

12.1 Immersion Soldering condition 浸焊条件

12.1 Immersion boldering condition (2/1-1/1)			
ITEM	CONDITION		
项目	条件		
Preheat temperature	110℃ Max (Ambient temperature of soldering surface of P.W.B)		
预热温度	110℃以下(印刷基板焊锡面周围的温度)		
Preheat time 预热时间	60s, Max 60 秒以内		
Area of flux	1/2 Max of PWB Thickness		
助焊剂面积	印刷基板厚度的 1/2 以内		
Temperature of solder	260±5℃		
焊锡温度	260±5℃		
Time of immersion	5s±0.5s		
浸焊时间	5 秒 ± 0.5 秒		
Number of soldering	2time Max (But should down heat of the first soldering)		
焊接次数	2次以内		
Printed wiring board	Single side copper-clad laminates		
印刷基板	单面铜箔		

- (1) After switches were soldered, please be careful not to clean switches with solvent 开关浸焊后,注意不要用溶剂清洗.
- (2) Under the condition of using soldering iron, soldering temperature shall be 350℃ max within 3 sec. 在使用铬铁的情况下,焊锡温度应在350℃以下,焊接时间3秒以内.



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12.2 Notes 注意点

- (1) Please be cautious not to give excessive static load or shock to switches. 注意不要施加超负荷的压力或晃动开关.
- (2) Please be careful not to stack up P. W. B. after switches were soldered. 开关焊接以后,印刷基板注意不要叠放.
- (3) Preservation under high temperature and high humidity or corrosive gas should be avoided Especially. When you need to preserve for a long period, do not open the carton. 保管时尤其应注意避开高湿高温和有腐蚀性气体的环境.如需长时间保存.请不要打开包装箱.
- (4) The standard storage period is 3 months, with maximum up to 6months, preferably to be used as soon as possible. After opening the package, you should put the remaining switches in a plastic bag to prevent from damp and corrosive gas.
 - 保存标准为3个月,限度为6个月以内,请尽早使用. 打开包装后,有剩余品时,应将剩余部分以胶袋包装 好以同外界隔离,请进行合适的防湿,防腐蚀气体等处理后进行保管.
- (5) This Product Specification is considered as the technical agreement on product between the receiving customer and Kailh. Any information on Product Catalogue which is in conflict with or different from the corresponding information of this document is considered as invalid.
 - 该规格书为客户与凯华公司产品在技术方面的共识,其他相关数据上与该规格书不一致的内容都是无效的.
 - (6) It will be considered that customer already confirmed and accepted this specification if customer issue purchase order to us directly.
 - 无论顾客收到规格书后有没有信息反馈直接向我公司订货,我们将认为顾客对此产品已验证合格.
- (7) If there is no order or no request for new specification after 1 year upon this specification is issued, the specification will be regarded as invalid.
 - 本产品规格书从生效日起 1 年后,如果没有订货或再次申请最新规格书时请做无效处理.
- (8) Products meet the ROHS & REACH environmental management substances control standards 产品满足 ROHS & REACH 环境管理物质管制标准